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### **EUROPEAN PATENT APPLICATION**

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(71) Applicant: CANON KABUSHIKI KAISHA Tokyo (JP) (72) Inventor: Yushiya, Akihiko, c/o Canon K.K. Tokyo (JP)

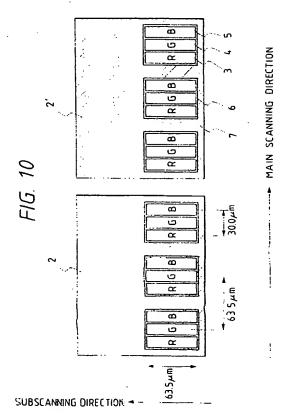
 (74) Representative:
 Beresford, Keith Denis Lewis et al BERESFORD & Co.

 2-5 Warwick Court High Holborn London WC1R 5DJ (GB)

### (54) Image pickup device

(57) There is disclosed an image pickup device comprising plural picture elements, each including plural pixels arranged in the longitudinal direction of the image sensor, wherein the picture elements are so arranged that the separating area between the picture elements

ements has a width larger than the distance between the centers of the pixels mutually adjacent within the picture element. Such arrangement enables high-quality image taking without generation of colored moiree fringes or false colors.



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#### Description

#### BACKGROUND OF THE INVENTION

### Field of the Invention

The present invention relates to an image pickup device for picking up the image of an object and converting it into an image signal.

### Related Background Art

As an image sensor for reading an original document, there is already known a contact multi-chip image sensor, composed of a light source, a short-focus imaging element array and plural line sensors. Figs. 1 to 4 illustrate an example of such image pickup device. Referring to Fig. 1. at the upper end of a frame 200, there is provided a transparent glass plate 201 capable of contacting an original document. Illuminating light 212. emitted from a light source 210 provided in the frame 200. illuminates the surface of the original document contacting the upper face of the transparent glass plate 201. The light 213 reflected from the original is transmitted through an optical system 209 and an infrared cutoff filter 211 and is focused on a sensor array 1 provided on a substrate 19, corresponding to the optical system 209

The above-mentioned optical system is composed. for example, of an array of imaging elements of a short focal length, such as Selfoc lens array (trade name of Japan Plate Glass Co., Ltd.). Also the above-mentioned light source is composed of a xenon tube or a cold cathode tube.

The sensor array 1 is constructed in the following manner. As shown in Fig. 2, the sensor array 1 is composed of a linear array of plural sensor chips 2, 2', 2", ... on the substrate 19, and is covered by a protective film 206. The substrate 19 is supported by a bottom plate 205 engaging with the frame 200 as shown in Fig. 1, and is connected to a flexible circuit board 203 through a flexible cable 208. The flexible board 203 is provided thereon with a connector 202 for the input/output of power supply and control signals, and the connector 202 is mounted, as shown in Fig. 3, on the frame 200 with screws 207

Fig. 4 shows the pixel arrangement in the vicinity of joints of the plural sensor chips 2. 2'. 2".... arranged linearly on the substrate 19 constituting the sensor array 1 R. G and B pixels 3. 4 5 respectively covered by R. G and B color filters are arranged in succession, with element isolation areas 6 therebetween, and these pixels release mutually independent signals. In the signal processing, the consecutive R G and B pixels are regarded to constitute a picture element, and the output signals of the R G B pixels are regarded as R. G. B components of the picture element. Such arrangement enables image reading with a high resolution.

In the following there will be briefly explained the color reproduction of a color original, utilizing the contact multi-chip color image sensor of the above-explained configuration. Fig. 5 shows a CIE-xy chromaticity diagram. in which an area surrounded by a solid line, consisting of a spectrum line and a red-purple line, includes all the colors. Fig. 6 shows the spectral sensitivity distribution of the R. G and B sensor in the contact multichip color image sensor. Fig. 13 shows spectral emission characteristics of an Xe tube. Fig 14 shows spectral transmission characteristics of an infrared cut-off filter and the chromaticity coordinates R. G. B of the sensors can be determined from Figs. 6. 13 and 14. An area inside a broken-lined triangle, having the corner points at the chromaticity ordinates R. G. B. indicates the color reproduction area of the contact multi-chip color image sensor.

If R. G. B signals r, g, b are obtained in a picture element by reading an original document, the color of the original is represented by the coordinate of the center of gravity when the r, g, b values are respectively placed at the points R. G. B in Fig. 5. As an example, if the original document is the white reference, there stands a relation r=g=b, so that the color of the white reference is represented by the coordinate of the center of gravity of the triangle RGB, representing the color reproducible area of the contact multi-chip color image sensor. Similarly the colors of the picture elements present in the original can be determined and the color reproduction can be achieved with R. G. B colors.

In the following there will be explained the method of representing the resolution of an image. There are known various methods for representing the resolution. but. in the following, explained is a method utilizing MTF. By reading a grid pattern as shown in Fig. 7 with an image sensor, there is obtained an output signal as shown in Fig. 8. The modulation transfer function (MTF) can be obtained by substituting the maximum value  $i_{\text{max}}$  and the minimum value  $i_{\text{min}}$  of such output signal into the following equation:

MTF = 
$$(i_{max} - i_{min})/(i_{max} + i_{min}) \times 100 (\%)$$

As the MTF of the sensor chip is generally sufficiently high, the MTF of the Selfoc lens array (SLA) used in the optical system is directly reflected in the MTF of the image sensor. Fig. 9 shows an example of the spatial frequency characteristics of such MTF

For example, in case of an image sensor with a resolution of 400 DPI and with a conventional pixel arrangement as shown in Fig. 4, the pitch of the picture elements is equal to about 63.5  $\mu$ m, while the distance between the pixels R and G or G and B constituting a picture element is about 21.2  $\mu$ m, and that between the pixels R and B is about 42.3  $\mu$ m. With such distances among the pixels, the optical system 209 has a resolution of about 3 fp/mm between the pixels R and G or G and B and 12 fp/mm between the pixels R and B According to Fig. 9, the MTF

of the optical system is sufficiently low, about 0 %, for a distance between the pixels R and G or G and B. but is about 30 % at a distance between the pixels R and B. corresponding to a considerable resolving power which is no longer negligible in comparison with the MTF of 50 % between the picture elements. Thus, if the optical system resolves the image light among the pixels constituting the picture element, there tend to be generated colored moiree fringes because of the difference in the optical positions, and there is provided a very unpleasant image particularly in case of a monochromatic image because of generation of false colors at the edge portion between black and white areas.

Such false color generation may be suppressed by reducing such colored moiree fringes for example through a signal processing so as to align the reading positions of the R. G. B pixels utilizing the outputs of the mutually adjacent pixels of a same color, but such method results in an increase in the circuit magnitude, because of the necessity for a memory for correcting the reading position, thus leading to an increased cost. Also the correction by such circuit alone cannot completely avoid the generation of such colored moiree fringes or false colors.

Also in case the sensor array is constituted by plural sensor chips, the spectral sensitivity characteristics may be different among such sensor chips, and the color space, constituting the basis of color reproduction, also becomes different among such sensor chips. For this reason, there may result an unnatural step difference in color, in the original image reading at the junction between the sensor chips. Particularly in case of an original which has a uniform color area over several sensor chips, there is reproduced a very unpleasant image with conspicuous streaks of color step difference:

### SUMMARY OF THE INVENTION

A concern of the present invention is to provide an image pickup device capable of image taking of high

Another concern of the present invention is to provide an image pickup device with an improved sensitivıty.

Still another concern of the present invention is to 45 provide an image pickup device free from generation of colored moiree fringes, false colors or color step differ-

In accordance with an embodiment of the present invention, an image pickup device is provided with an image sensor for converting the image light from an object into an electrical signal, and the image sensor comprises plural picture elements, each including plural pixels arranged in the longitudinal direction of the sensor. in which the picture elements are so arranged that a separating area between the picture element has a width larger than the distance between the pixels adjacent within the picture element and the MTF for a distance

between any two pixels that constitutes one picture element is sufficiently low.

According to a second aspect of the present invention, there is provided an image pickup device provided with an array of plural image sensors, each consisting of plural sensors for different colors, wherein the image sensors, showing largest relative difference in the spectral sensitivity characteristics in sensors of at least a color, are not placed in mutually adjacent positions.

According to a third aspect of the invention, there is provided an image pickup device provided with an array of plural image sensors of mutually different spectral sensitivity characteristics, wherein, among the plural image sensors, image sensors with largest different in the spectral sensitivity characteristics are not placed in mutually adjacent positions.

It is thus rendered possible to provide an image pickup device capable of image taking of high quality. also to provide an image pickup device of an improved sensitivity, and to provide an image pickup device free from generation of colored moiree fringes. false colors and color step difference.

Still other features of the present invention will become fully apparent from the following description. which is to be taken in conjunction with the attached drawings.

### BRIEF DESCRIPTION OF THE DRAWINGS

Fig. 1 is a cross-sectional view of a contact multichip image sensor utilizing Xe tube as a light source:

Fig. 2 is a plan view of a sensor array:

Fig. 3 is an external perspective view of a contact multi-chip image sensor:

Fig. 4 is a view showing the arrangement of pixels in a conventional sensor chip:

Fig. 5 is an x-y chromaticity diagram of a sensor:

Fig. 6 is a chart showing spectral sensitivity characteristics of R. G. B sensors:

Fig. 7 is a chart showing a grid pattern for MTF measurement:

Fig. 8 is a chart showing the output signal wave form of an image sensor at the MTF measurement:

Fig. 9 is a chart showing an example of MTF characteristics:

Fig. 10 is a view showing the pixel arrangement in sensor chips in a first embodiment:

Fig. 11 is an x-y chromaticity diagram of green sensors in a second embodiment:

Fig. 12 is a chart showing the spectral sensitivity characteristics of green sensors in the second em-

Fig. 13 is a chart showing the spectral emission characteristics of an Xe tube in the second embod-

Fig. 14 is a chart showing the spectral transmission. characteristics of an infrared cut-off filter in the sec-

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ond embodiment:

Fig. 15 is an x-y chromaticity diagram of sensor chips in the second embodiment:

Fig. 16 is a chart showing grouping ranges in the second embodiment:

Fig. 17 is a chart showing grouping by x-y chromaticity of B sensors in the second embodiment:

Fig. 18 is a chart showing grouping by x-y chromaticity of R sensors in the second embodiment:

Fig. 19 is a cross-sectional view of a contact multichip image sensor of a third embodiment:

Fig. 20 is a view of an LED board in the third embodiment:

Fig. 21 is a view showing the arrangement of pixels in the sensor chips of the third embodiment:

Fig. 22 is a chart showing the spectral sensitivity characteristics of sensor chip; and

Fig. 23 is a chart showing the spectral emission characteristics of LED's of R. G. B in the third embodiment

## DESCRIPTION OF THE PREFERRED EMBODIMENTS

Fig. 10 is a view showing the configuration of an image sensor constituting a first embodiment of the present invention. The image sensor of the present embodiment is a multi-chip image sensor in which a sensor array is composed of plural sensor chips wherein three pixels (R. G and B) constituting a picture element are arranged in the main scanning direction, which is the longitudinal direction of the image sensor, and a pixel separating area (light shielding area) is provided between the picture elements.

The basic structure of the image pickup device is same, also in case of the image sensor of the present embodiment, as that shown in Fig. 1 and will not, therefore, be explained further.

In the image sensor shown in Fig. 10, the pitch between the centers of the mutually adjacent picture elements is about 63.5 µm, but, because of the presence of a light shielding area 7 between the picture elements, the pitch of the pixels R and G or G and B within a picture element is about 15.0 µm and that of the pixels R and B is about 30.0 µm. With such positional arrangement, the optical system 209 has a resolution of 8 fp/mm between the picture elements. 32 fp/mm between the pixels R-G or G-B and 16 fp/mm between the pixels R-B. Thus, according to Fig. 9, the MTF value is about 50 % between the picture elements, about 0 % between the pixels R-G. G-B or R-B and about 10 % between the pixels R-B.

As explained in the foregoing, in the image sensor, it is desired that the MTF characteristics of the optical system have a high resolution among the picture elements and a low resolution between the pixels R-G. G-B or R-B constituting a picture element. The pixel arrangement of the present embodiment allows to reduce

the resolution between the pixels R-G. G-B or R-B constituting a picture element, while maintaining the resolution between the picture elements, thereby optically reducing the colored moiree fringes and providing an image of high quality without the addition of a particular signal processing circuit.

Also the pixel arrangement of the present embodiment can resolve the moiree fringes, resulting from the joint of the sensor chips, in addition to the suppression of the resolution among the R. G. B pixels within each picture element. Besides the reading sensitivity can be improved as the area of aperture within each picture element can be increased.

As explained in the foregoing, the image pickup device of the present embodiment is provided with an image sensor for receiving the light from an object and converting the light into an electrical signal, and an optical system for focusing the image light from the object onto the image sensor, wherein, in the image sensor, plural pixels for different colors are arranged along the main scanning direction to constitute a picture element and a pixel separating area is provided between the adjacent picture elements, in which the picture elements are arranged with a pitch resolvable by the optical system while the pixels constituting each picture element are arranged with such a pitch that lowers the resolution by the optical system. Such configuration enables to optically prevent the colored moiree fringes, thus avoiding generation of unpleasant false colors for example at the edge portions of a black-and-white image. It is also rendered possible to achieve high-quality image reading with the image sensor, without increase in the circuit magnitude or in the memory capacity. It is furthermore rendered possible to achieve image taking of high quality, without increase in cost, by the image pickup device utilizing such image sensor.

The image sensor of the present embodiment is composed of R. G and B pixels, but it may also be composed of pixels of other colors, for example yellow, magenta and cyan.

Also the order of arrangement of these colors is not limited to the example of the present embodiment.

Fig. 11 is a CIE-xy chromaticity diagram, similar to Fig. 5, showing the grouped spectral sensitivity characteristics of sensor chips in a second embodiment. In Fig. 11, each plot represents the x-y chromaticity of G sensors of 10 chips. In the contact multi-chip color image sensor of the present embodiment, the x-y chromaticity of the G sensor can be determined from the following calculation. From the spectral characteristics of the constituents, the tristimulus values Xg. Yg. Zg of the G sensor in the CIE. 1931 standard colorimetric system are given by:

 $Xg = K_{\lambda}^{2}Xe(\lambda) IR(\lambda) SG(\lambda) x(\lambda) d\lambda$   $Yg = K_{\lambda}^{2}Xe(\lambda) IR(\lambda) SG(\lambda) y(\lambda) d\lambda$ 

## Zg = K $\frac{1}{2}$ Xe ( $\lambda$ ) IR ( $\lambda$ ) SG ( $\lambda$ ) z ( $\lambda$ ) d $\lambda$ K = 100/ $\frac{1}{2}$ Xe ( $\lambda$ ) IR ( $\lambda$ ) y ( $\lambda$ ) d $\lambda$

wherein

Xe (λ):	spectral emission characteristics of a
	Xe tube:
IR (λ):	spectral transmission characteristics
	of an infrared cut-off filter:
SG (λ):	spectral sensitivity characteristics of a
	single G sensor

x. y. z ( $\lambda$ ): color matching functions.

SG ( $\lambda$ ), Xe ( $\lambda$ ) and IR ( $\lambda$ ) have characteristics as respectively shown in Figs. 12 to 14. Also the tristimulus values Xr. Yr. Zr of the R sensor and those Xb. Yb. Zb of the B sensor can be similarly determined by replacing. in the foregoing equations, the spectral sensitivity characteristics SG ( $\lambda$ ) of the single G sensor with that SR ( $\lambda$ ) of the single R sensor and with that SB ( $\lambda$ ) of the single B sensor.

The CIE-xy chromaticity coordinates of the G sensor can be determined by substituting the tristimulus values Xg, Yg. Zg. obtained from the foregoing equations. into following equations:

$$xg = Xg / (Xg + Yg + Zg)$$

$$yg = Yg / (Xg + Yg + Zg)$$

The xy chromaticity coordinates xr. yr of the R sensor and those xb. yb of the B sensor can also be determined in a similar manner.

The sensor chips are classified, for example, into two groups A and B, according to thus determined xy chromaticity of G sensor as shown in Fig. 11. The difference in chromaticity of the G sensors arises only from the difference in the spectral sensitivity characteristics of each G sensor, since other components are common in a contact multi-chip color image sensor.

For the simplicity of explanation. let us assume that the R or B sensors have the identical chromaticity characteristics. In such case, the G sensors of chips, respectively selected from the groups A and B, will show color spaces as shown in Fig. 15 as an example. Consequently, if the sensor array is constructed without such grouping, the sensor chips having both color spaces A, B may be mixedly present within a sensor array.

As a result, a picture element of a chromaticity C1 will be reproduced differently as C1A and C1B, respectively by the sensor chips of the color spaces A and B though there exists only one original color. As the picture elements within a sensor chip provide relatively uniform chromaticity in reproduction, the difference in the chromaticity characteristics between the sensor chips appears as a color step difference on the reproduced image

Therefore, by constituting the sensor array from the

sensor chaps belonging only to a group, such sensor chips have relatively similar color spaces, so that it is made possible to reduce the difference in color characteristics among the sensor chips and to reduce the color step difference.

In practice, however, it is not enough to classify the sensor chips according to the chromaticity characteristics of the G sensors only, because the spectral sensitivity characteristics of the sensor chips show fluctuation not only in the G sensors but also in the R and B sensors. For this reason, in the present embodiment, the grouping is also conducted for the R and B sensors by calculating the xy chromaticity coordinates thereof, as in the case of G sensors, and each sensor array is constituted by the sensor chips which belong to a same group of classification for three colors, whereby the color spaces of the sensor chips are made mutually close.

Fig. 16 shows the ranges of fluctuation of the xy chromaticity of the R. G. B sensors among the sensor chips and the ranges of grouping thereof. Fig. 17 shows the distribution of xy chromaticity of the B sensors in 10 sensor chips and the grouping thereof. and Fig. 18 similarly shows the distribution of xy chromaticity of the R sensors in 10 sensor chips. By dividing the R and G sensors respectively in two groups and the B sensors into four groups. the sensor chips are classified into 16 groups of different chromaticity characteristics according to the combination of R. G and B. By constructing each sensors array from the sensor chips belonging only to a group selected from so many groups, the color spaces of the constituting sensor chips are made even closer and the color step difference can be securely reduced.

As explained in the foregoing, it is rendered possible to provide a contact multi-chip color image sensor capable of image reading with highly uniform color characteristics over the entire pixel area. by classifying the sensor chips, constituting said image sensor, into plural groups according to the similarity of the color reproducible area of each sensor chip and constructing each sensor array with the sensor chips belonging only to a group.

In the present embodiment, the grouping of the sensor chips is conducted according to the color reproducible area of such sensor chips in the CIE 1931 standard colormetric system, but a similar grouping may be conducted in other color space such as CIELAB color space or CLELUV space. Also such concept is naturally applicable to other similar color image sensors such as of filter switching type or rotating prism type.

Fig. 19 is a cross-sectional view of a contact multichip color image sensor constituting a third embodiment. The foregoing second embodiment discloses an image sensor provided with color filters, but the present embodiment describes an image sensor of light source switching type.

The color image sensor of light source switching type is composed of monochromatic sensor chips with-

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out color filters and light sources of three colors. wherein the color information is obtained from the output signals of the monochromatic sensor chips when the light sources of three colors are alternately turned on in a position on the original image. The present embodiment employs LED's of R. G and B colors, but there may also be employed other colors or other light sources. In Fig. 19 there are shown a sensor array 1' consisting of an array of monochromatic sensor chips without color filters: a frame 200': an LED 221: and an LED board 220 on which LED's are mounted.

As shown in Fig. 20. the LED's 221 consist of those 221R. 221G. 221B respectively of R. G and B colors. which are arranged in a linear array and those of each color can be independently turned on and off. The light 222 emerging from the LED's 221 illuminates a face of the original placed in contact with the upper face of a transparent glass plate 201. and the light 223 reflected from the image-bearing face of the original enters the sensor array 1'. provided on a board 19. through an optical system 209. As shown in Fig. 21. the sensor array 1' is composed of sensor chips 22. 22'. .... each of which is provided with a linear array of apertures 24 which are not provided with color filters and which are mutually separated by an element separating area 26 and light shielding areas 7.

Also in such contact multi-chip color image sensor of light switching type, the color space can be determined as in the foregoing second embodiment. For example, the tristimulus values Xg, Yg, Zg of G color can be obtained from:

$$Xg = K I L G(\lambda) S(\lambda) x(\lambda) d\lambda$$

$$Yg = K LG(\lambda) S(\lambda) y(\lambda) d\lambda$$

$$Zg = K \int LG(\lambda) S(\lambda) z(\lambda) d\lambda$$

$$K = 100 / \int D65 (\lambda) y (\lambda) d\lambda$$

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LG (λ)	spectral emission characteristics of
	GLED:
S (\(\lambda\):	spectral sensitivity characteristics of a
	single monochromatic sensor:
D65 (?.)	spectral emission characteristics of a
	standard D65 light source:
x. y. z (λ):	color matching functions of CIE 1931
	standard colormetrick system

S ( $\lambda$ ) and LG ( $\lambda$ ) have characteristics as respectively shown in Figs. 22 and 23. Also the tristimulus values Xr. Yr. Zr of R color and those Xb. Yb. Zb of B color can be similarly determined by replacing, in the foregoing equations, the spectral emission characteristics LG ( $\lambda$ ) of the GLED with those LR ( $\lambda$ ) of RLED and those LB ( $\lambda$ ) of BLED

The CIE-xy coordinates of the G color can be de-

termined by substituting the tristrimulus values Xg. Yg. Zg. obtained from the foregoing equations, into following equations:

$$xg = Xg / (Xg + Yg + Zg)$$

$$yg = Yg / (Xg + Yg + Zg)$$

The xy coordinates xr. yr of the R color and those xb. yb of the B color can also be determined in a similar manner

Also in the color image sensor of light source switching type, the R. G. B chromaticity coordinates, defining the color spaces, can be determined according to the above-explained procedure. Thus, by measuring the spectral sensitivity characteristics of each monochromatic sensor chip and classifying the sensor chips according to thus calculated chromaticity coordinates, it is rendered possible to construct each contact multi-chip color image sensor only with the sensor chips of similar chromaticity characteristics as in the second embodiment and to improve the quality of the read image.

It is thus rendered possible to provide a contact multi-chip color image sensor capable of image reading with highly uniform color characteristics over the entire pixel area, by classifying the sensor chips, constituting the image sensor, into plural groups according to the similarity of the color reproducible area of each sensor chip and constructing each sensor array with the sensor chips belonging only to a group.

#### Claims

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- An image pickup device provided with an image sensor for converting the light from an object into an electrical signal.
  - wherein said image sensor comprises plural picture elements. each consisting of plural pixels arranged in the longitudinal direction of sensor, said picture elements being so arranged that a separating area between said picture elements has a width larger than the distance between the centers of the pixels mutually adjacent within said picture element.
- An image pickup device according to claim 1, wherein each of said picture elements is composed of plural pixels of mutually different colors
- 3. An image pickup device according to claim 2, wherein each of said picture elements is composed of three pixels of red, green and blue colors
- An image pickup device according to claim 1, wherein said image sensor is composed of plural sensor chips each including plural picture elements

- 5. An image pickup device according to claim 1. further comprising an optical system for focusing the image light from said object onto said image sensor wherein. in said image sensor, the picture elements are arranged with a pitch resolvable by said optical system and the pixels constituting said picture elements are arranged with such a pitch as to lower the resolution by said optical system.
- 6. An image pickup device according to claim 5. wherein each of said picture elements is composed of plural pixels of mutually different colors.
- 7. An image pickup device according to claim 6. wherein each of said picture elements is composed 15 of three pixels of red. green and blue colors.
- 8. An image pickup device according to claim 5. wherein said image sensor is composed of plural sensor chips, each including plural picture ele- 20 ments.
- 9. An image pickup device comprising plural image sensors each including plural sensors of different colors, wherein the image sensors, showing largest 25 relative difference in the spectral sensitivity characteristics in sensors of at least a color, are not placed in mutually adjacent positions.
- 10. An image pickup device according to claim 9. wherein said image sensor is composed of sensors of red. green and blue colors.
- 11. An image pickup device comprising plural image sensors of different spectral sensitivity characteristics, wherein, among said plural image sensors. those showing largest relative difference in the spectral sensitivity characteristics are not placed in mutually adjacent positions.
- 12. An image pickup device according to claim 11 wherein said image sensors are monochromatic and the image of an object is taken by switching plural light sources of different colors
- 13. An image pickup device according to claim 12. wherein said light sources have red, green and blue colors.
- 14. An image sensor for converting light into an electrical signal, and comprising plural picture elements arranged in a linear direction each of which picture elements includes a plurality of individual pixel sensors arranged in the same direction, and wherein adjacent picture elements are separated by a separation area the width of which is greater than the spacing between the centres of adjacent pixel sensors in a picture element

FIG. 1

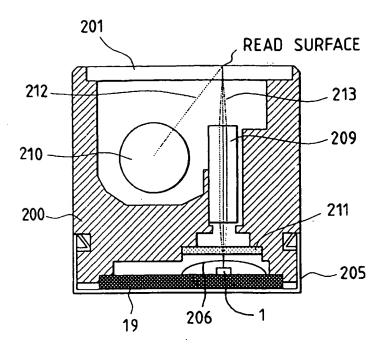
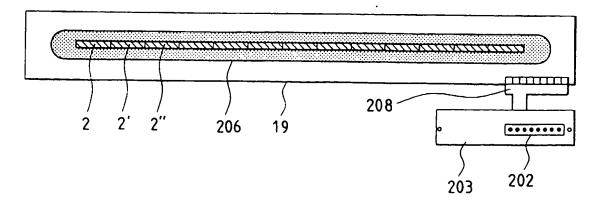
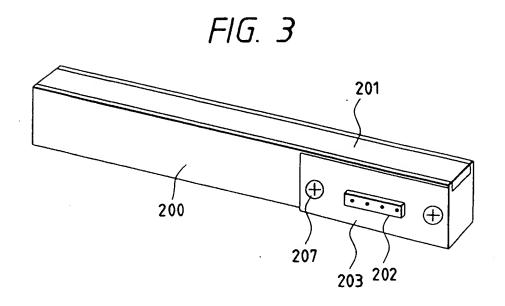
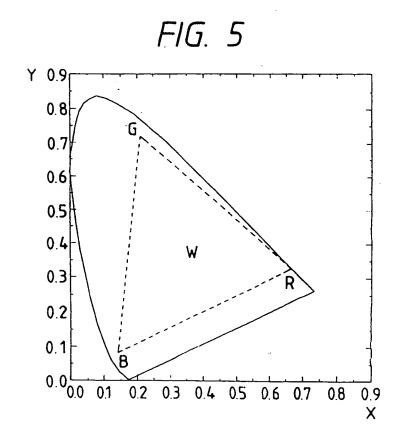
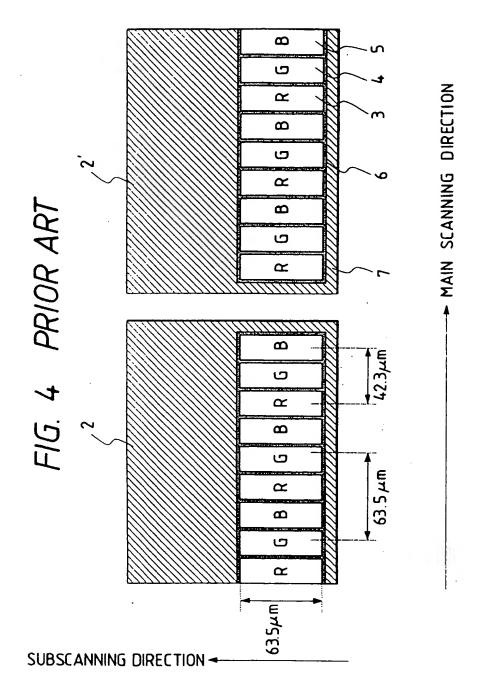


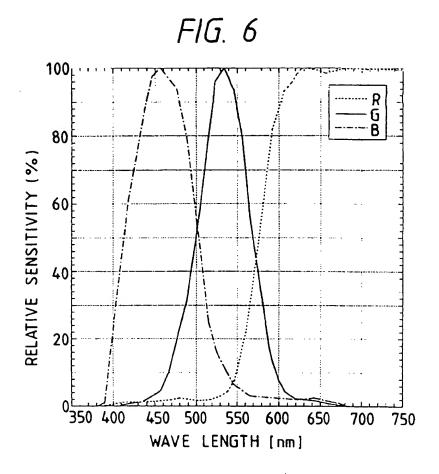
FIG. 2

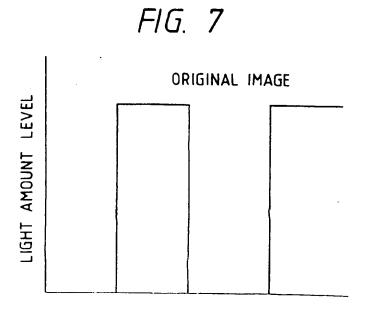


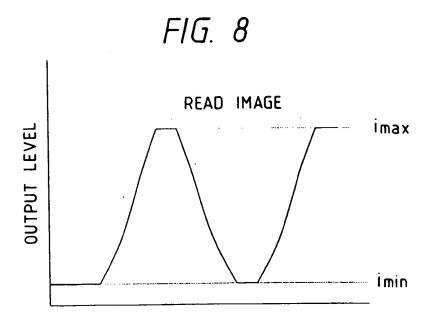


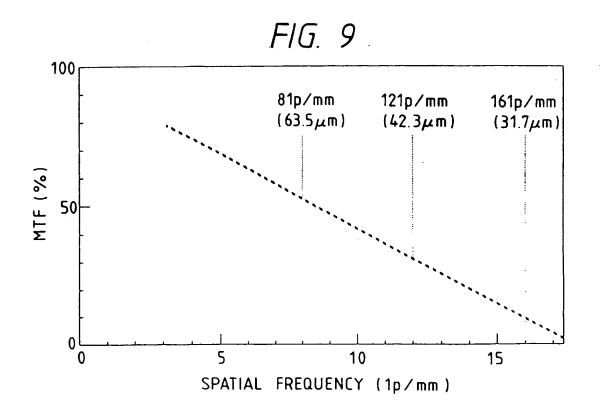


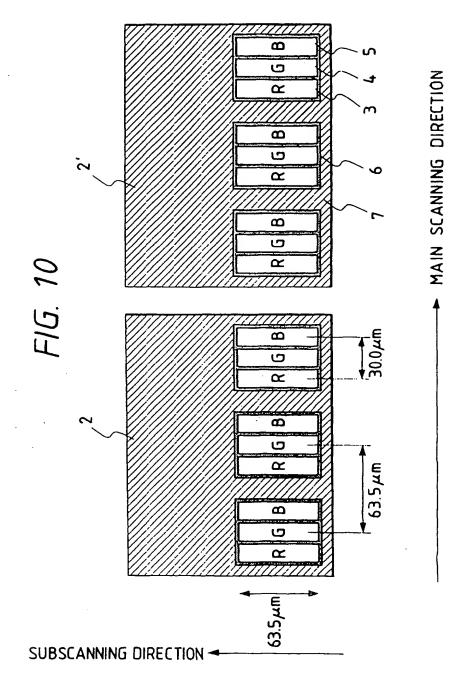


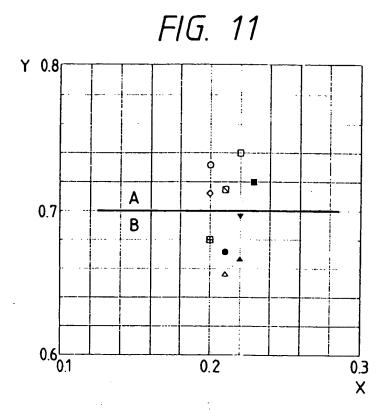












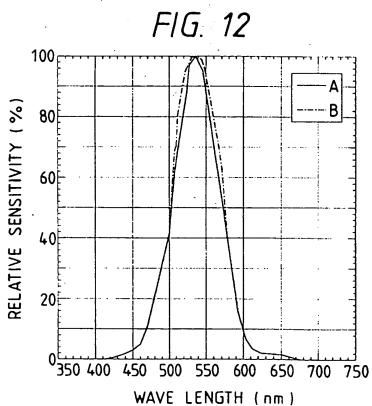


FIG. 13

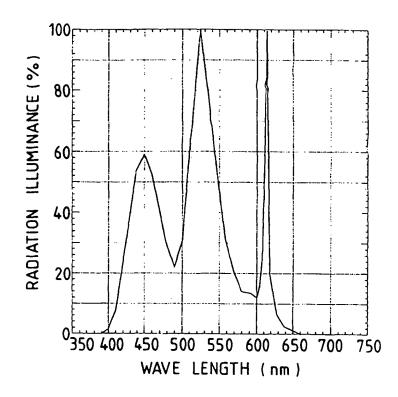


FIG. 14

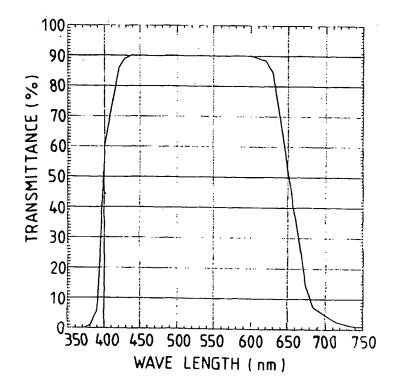


FIG. 15

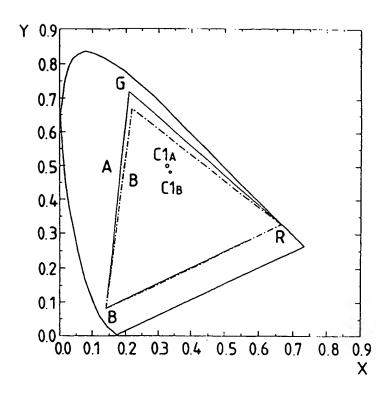
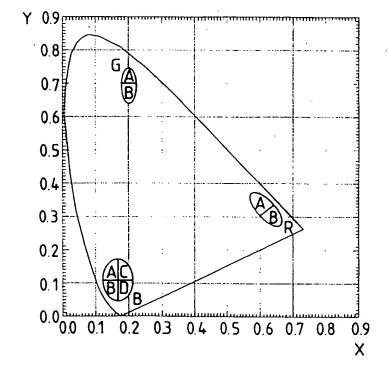
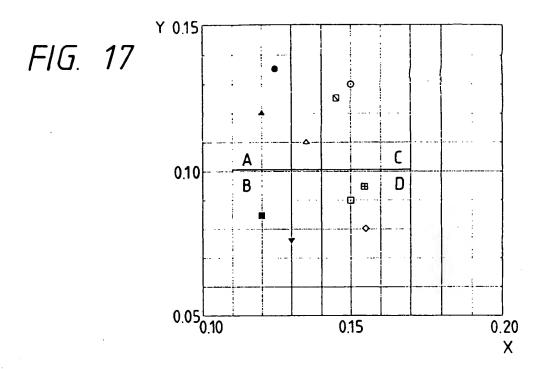
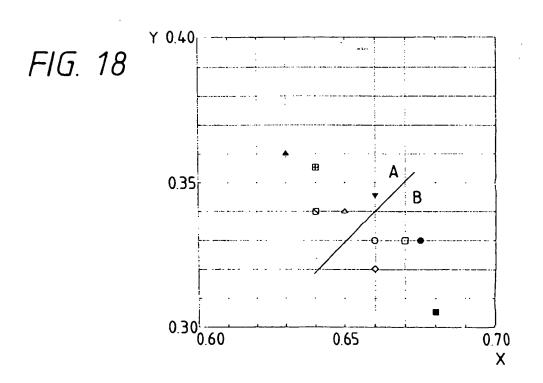
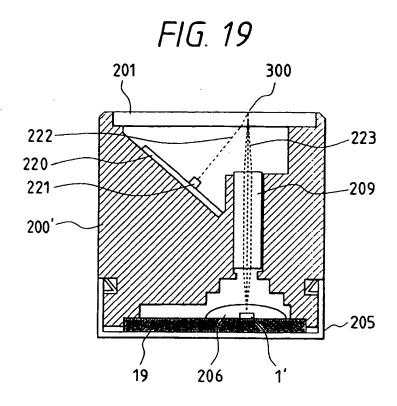


FIG. 16

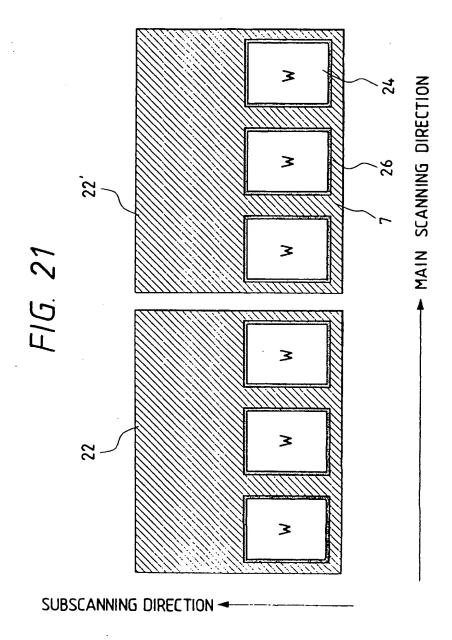


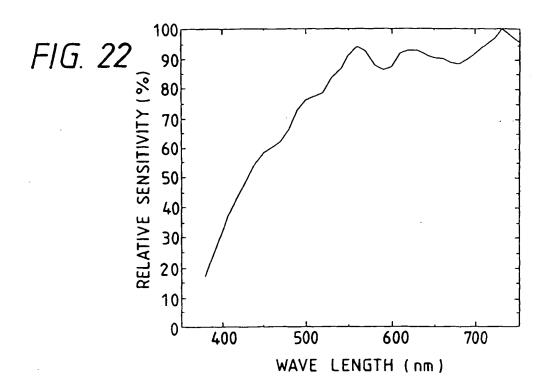


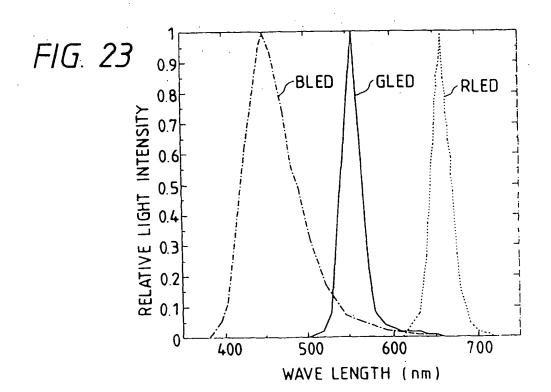




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# Europäisches Patentamt European Patent Office Office européen des brevets



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(12)

### **EUROPEAN PATENT APPLICATION**

(88) Date of publication A3: 12.02.1997 Bulletin 1997/07

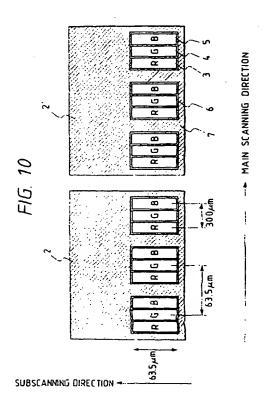
(51) Int CI.6: H04N 1/50, H04N 1/48

(11)

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- (71) Applicant: CANON KABUSHIKI KAISHA Tokyo (JP)
- (72) Inventor: Yushiya, Akihiko, c/o Canon K.K. Tokyo (JP)
- (74) Representative:
  Beresford, Keith Denis Lewis et al
  BERESFORD & Co.
  2-5 Warwick Court
  High Holborn
  London WC1R 5DJ (GB)

### (54) Image pickup device

(57) There is disclosed an image pickup device comprising plural picture elements, each including plural pixels arranged in the longitudinal direction of the image sensor, wherein the picture elements are so arranged that the separating area between the picture elements has a width larger than the distance between the centers of the pixels mutually adjacent within the picture element. Such arrangement enables high-quality image taking without generation of colored moiree fringes or false colors.



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### **EUROPEAN SEARCH REPORT**

EP 95 30 8796

ategory	Citation of document with in		Relevant	CLASSIFICATION OF THE
- Each	of relevant pas	32ges	to claim	APPLICATION (Int.CL6)
	US 4 870 483 A (NISH * abstract; figures * column 6, line 48	NIGAKI ET AL) 12,13 * - line 61 *	1-8,14	H04N1/50 H04N1/48
,	US 4 855 817 A (WATA * abstract; figure 1	NABE)	1-8,14	
			,	
				TECHNICAL FIELDS
	<u> </u> :		1	SEARCHED (Int.Cl.6)
				H04N
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	i			
	The present search report has h		<u>i</u>	
	Place of search	Date of completion of the sea	1	Examinor
	THE HAGUE	19 September	1996 [	SA S.
Y : pa	CATEGORY OF CITED DOCKMES cricularly relevant if taken alone cricularly relevant if combined with and cument of the same category, choological background.	E : earlier par after the f other D : document L : document	cited in the applicat	ublished on, or tion

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CLAIMS INCURRING FEES			
The prese	ent European patent application comprised at the time of filling more than ten claims		
	All claims fees have been paid within the prescribed time limit. The present European search report has been drawn up for all claims.		
	Only part of the claims fees have been paid within the prescibed time limit. The present European search report has been drawn up for the first ten claims and those claims for which fees have been		
	namely claims:		
	No claims fees have been paid within the prescribed time limit. The present European search report has been drawn up for the first ten claims.		
LA	CK OF UNITY OF INVENTION		
	ch Division considers that the present European patent application does not comply with the requirement by of the invention and relates to several inventions or groups of inventions, namely:		
•			
•			
	All further search fees haven been paid within the fixed time limit. The present European search record has been drawn up for all claims.		
	Only part of the further claims fees have been baid within the prescibed time limit. The present European search report has been drawn up for for those parts of the European patent application which relate to the inventions in respects of which search fees have been paid.		
	namely claims:		
Ø	None of the further claims fees have been baild within the prescibed time limit. The present European search report has been drawn up for for those parts of the European patent application which relate to the invention first mentioned in the claims.		
	namely claims:		



### European Patent Office

EP 95 30 8796 - B -

### LACK OF UNITY OF INVENTION

The Search Division considers that the present European patent application does not comply with the requirement of unity of invention and relates to several inventions, namely:

1. Claims 1-8.14 : Im-

Image pickup device having image sensor having a plurality of picture elements, wherein the separating area between picture elements is larger than the distance between pixels within one

picture element.

Claims 9-13

Image pickup device having a plurality of image sensors having a plurality of sensors of different colours, wherein the sensors

are arranged according to their spectral sensitivity

characteristics.